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April 2016

HI-8200, HI-8201, HI-8202

Quad 10 Ohm +/-12V outside-the-rails Analog Switch with Open Circuit when Power Off

GENERAL DESCRIPTION

The HI-8200 is a quad analog CMOS switch fabricated with Silicon-on-Insulator (SOI) technology for latch-up free operation and maximum switch isolation. High voltage gate drive is entirely created on-chip enabling +/-12V switching range from a single 3.3V or 5V supply. These switches are ideally suited for applications demanding low switch leakage when the power pins are 0V.

At 25°C and with VDD from 3.0V to 5.5V, the switch resistance (RON) is typically 8Ω . RON is independent of VDD. In a switching range of -5V to +5V, the maximum deviation of RON from flat is less than 5%.

These switches conduct equally well in either direction. Power down and Off state leakages are less than 10nA maximum. Charge injection is less than 10pC. Switching times are typically 180ns to the On state and 60ns to the Off state. The onboard charge pump allows an On/Off cycle time of 5KHz for all four switches simultaneously before the switching range becomes restricted.

The HI-8200 provides four each normally open switches when the switch control inputs are low. The HI-8201 provides four each normally closed switches when the switch control inputs are low. The HI-8202 provides a combination of two normally closed and two normally open switches.

Industry-standard plastic package options include 20-pin TSSOP, 16-pin DIP and 16-pin QFN. Ceramic packaging is available on request. All three products are offered in both industrial (-40°C to +85°C) and extended (-55°C to +125°C) temperature range options.

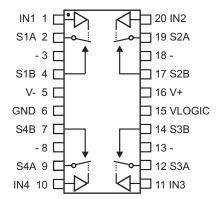
APPLICATIONS

- Avionics
- Data bus isolation
- · Sample-and-Hold circuits
- Test Equipment
- Communications Systems

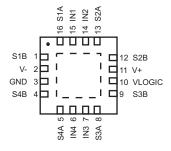
FEATURES

- CMOS analog switches with up to +/-12V switching range from a single 3.3V or 5V supply
- Low RON: 10Ω max at 25°C
- · Robust CMOS Silicon-on-Insulator (SOI) technology
- · Switch nodes are open-circuit when chip is powered down
- SOI switch isolation with 1nA typical Off leakage
- ESD protection > 4KV HBM
- · Fast switching time with break-before-make
- Low power
- Extended Temperature Range (-55°C to +125°C)

PIN CONFIGURATIONS (Top Views)



HI-8200PSx 20-Pin TSSOP package



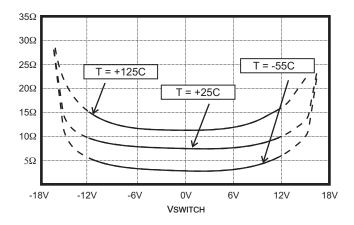
HI-8200PCx
16-pin 5mm x 5mm Chip-scale package
(see page 6 for additional package configurations)

| PRODUCT OPTIONS | | | | | | | | |
|-----------------|-----|----------|-----|----------|-----|----------|-----|----------|
| PART TYPE | IN1 | Switch 1 | IN2 | Switch 2 | IN3 | Switch 3 | IN4 | Switch 4 |
| HI-8200 | 0 | Open | 0 | Open | 0 | Open | 0 | Open |
| | 1 | Closed | 1 | Closed | 1 | Closed | 1 | Closed |
| HI-8201 | 0 | Closed | 0 | Closed | 0 | Closed | 0 | Closed |
| | 1 | Open | 1 | Open | 1 | Open | 1 | Open |
| HI-8202 | 0 | Open | 0 | Closed | 0 | Closed | 0 | Open |
| | 1 | Closed | 1 | Open | 1 | Open | 1 | Closed |

PIN DESCRIPTIONS

| SIGNAL | FUNCTION | DESCRIPTION |
|--------|-------------|--|
| IN1 | Logic Input | HI-8200 and HI-8202 are normally Open when input Low |
| S1A | Switch Node | Switch 1 Node |
| S1B | Switch Node | Switch 1 Node |
| V- | CAP - | Bulk storage capacitor. Add 0.1uF ceramic capacitor to GND. (20V or higher). |
| GND | Supply | Reference Ground |
| S4B | Switch Node | Switch 4 Node |
| S4A | Switch Node | Switch 4 Node |
| IN4 | Logic Input | HI-8200 and HI-8202 are normally Open when input Low |
| IN3 | Logic Input | HI-8201 and HI-8202 are normally Closed when input Low |
| S3A | Switch Node | Switch 3 Node |
| S3B | Switch Node | Switch 3 Node |
| VLOGIC | Supply | 3.3V or 5.0V Logic supply |
| V+ | CAP + | Bulk storage capacitor. Add 0.1uF ceramic capacitor to GND. (20V or higher). |
| S2B | Switch Node | Switch 2 Node |
| S2A | Switch Node | Switch 2 Node |
| IN2 | Logic input | HI-8201 and HI-8202 are normally Closed when input Low |

NOTE: V+ and V- pins are **only** to be used for connection of bulk storage capacitors and **MUST NOT** be loaded.



Typical Ron as a function of Vswitch and Temperature (10mA switch current, Vsupply = +3.3V)

ABSOLUTE MAXIMUM RATINGS

(Voltages referenced to GND = 0V)

| Continuous Power Dissipation (TA=70°C): SO Package (derate 6.7mW/°C above 70°C)696mW Plastic DIP (derate 10.53 mw/°C above 70°C)842mW Thin QFN (derate 21.3mW/°C above 70°C)1702mW |
|---|
| Storage Temperature Range:65°C to +150°C |
| Ceramic |
| |

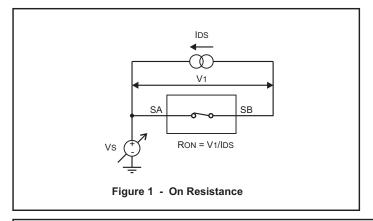
NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

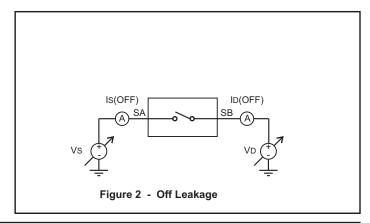
ELECTRICAL CHARACTERISTICS

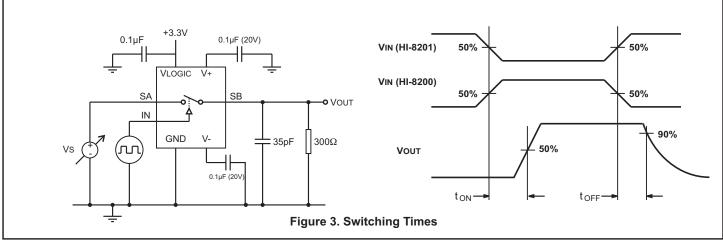
VLOGIC = 3.3V or 5.0V, GND = 0V. Operating temperature range (unless otherwise noted).

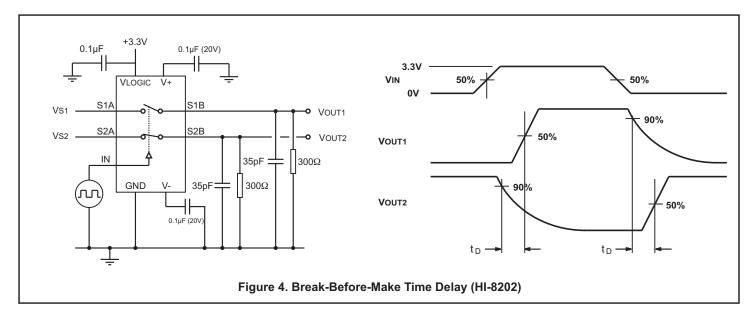
| DADAMETED | 0.44501 | CONDITIONS | FIGURE | BAINI | TVD | MAY | LINUT |
|---|-------------|--|--------|-------|----------|------------|----------------|
| PARAMETER | SYMBOL | CONDITIONS | FIGURE | MIN | TYP | MAX | UNIT |
| SWITCH PARAMETERS | | | | | | | |
| Switch Resistance, 25°C, 10mA | Ron | 12V > Vs > -12V | 1 | 6 | 8 | 10 | Ω |
| Leakage - (open circuit and power down) | Iswleak | 12V > Vs > -12V | 2 | | 1 | 10 | nA |
| Leakage - (open circuit and power on) | ISWLEAKp | 12V > Vs > -12V | 2 | | 1 | 100 | nA |
| LOGIC INPUTS | | | | | | | |
| Input High Voltage | ViH | | | 75% | | | V |
| Input Low Voltage | VIL | | | | | 25% | V |
| Input Current | lih lil | 80K Ohm pulldown VLogic = 3.3V Vlogic = 5.0V | | | 45 65 | 0.5 | μΑ μΑ μΑ |
| SUPPLY | | | | | | 0.0 | μ, . |
| VLogic Operating Range | VDD | | | 3.0 | | 5.5 | V |
| VLogic Operating Current | IDD | inputs static VLogic = 3.3V Vlogic = 5.0V | | | | 1.0 2.5 | mA mA |
| DYNAMIC PARAMETERS | | | | | | | |
| Max Vin On/Off cycling | fcycle | any load | | | | 5 | Khz |
| Turn On Time | Ton | | 3 | | 180 | 250 | ns |
| Turn Off time | Toff | | 3 | | 80 | 150 | ns |
| Break-Before-Make Time | TD | | 4 | 40 | 80 | | ns |
| Charge Injection | Q | Vs=0V, Rs=0Ω, 25°C | 5 | | -20 | | pC |
| Off Isolation | RR | f = 1 MHz, 25°C | 6 | | 65 | | dB |
| Crosstalk | CR | f = 1 MHz, 25°C | 7 | | 90 | | dB |
| Capacitance | Coff Con | Switch Off, 25°C Switch On, 25°C | 8 9 | | 15 60 | | pF pF |
| Charge Pump Power On | Tvon | V+ and V- = +/-14.5V VLogic = 5.0V | 10 | 10 | | | ms |

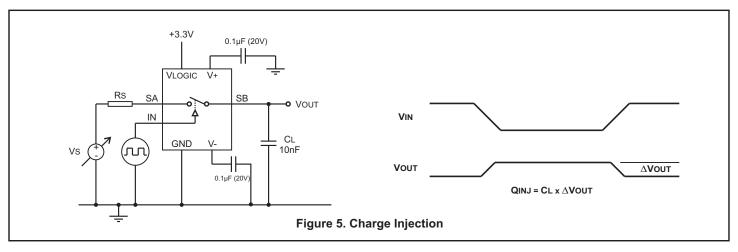
TEST CIRCUITS

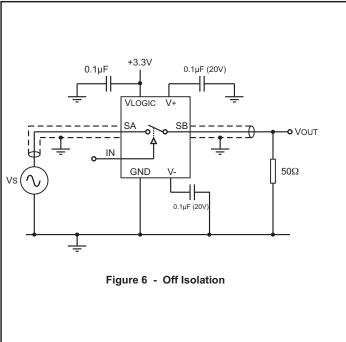


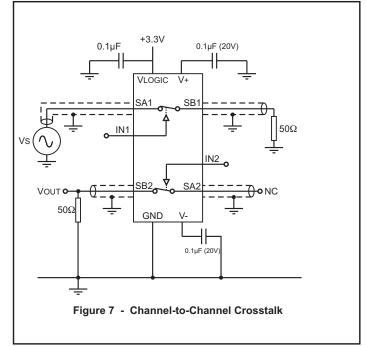


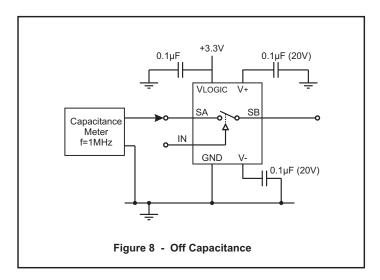


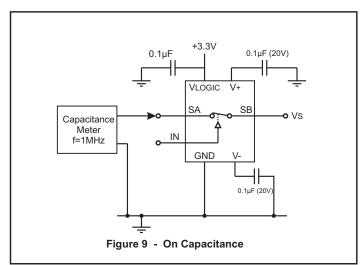


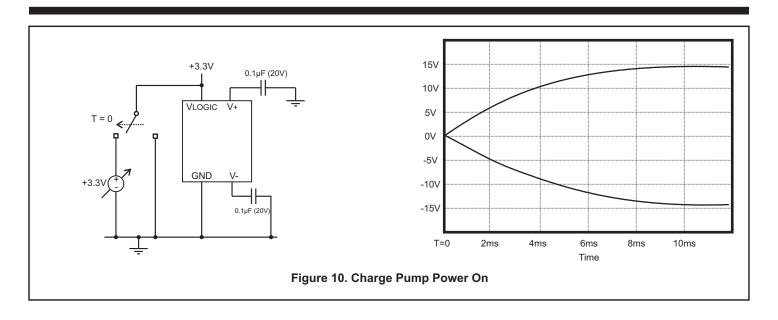




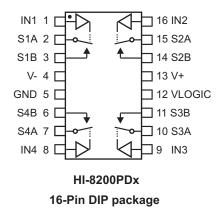








Additional package configurations



ORDERING INFORMATION

HI - <u>820x xx x</u> <u>x</u>

| PART NUMBER | LEAD FINISH |
|----------------|-----------------------------|
| Blank | Tin / Lead (Sn / Pb) Solder |
| F | Pb-free, RoHS compliant |

| PART NUMBER | TEMPERATURE RANGE | FLOW | BURN IN | |
|----------------|----------------------|------|------------|--|
| I | -40°C TO +85°C | 1 | NO | |
| Т | -55°C TO +125°C | Т | NO | |
| М | -55°C TO +125°C | М | YES | |

| PART NUMBER | PACKAGE DESCRIPTION |
|----------------|---|
| PC | 16 PIN PLASTIC 5 x 5 mm CHIP SCALE (16PCS1) (No M-flow, Pb-free only) |
| PS | 20 PIN PLASTIC TSSOP (20HS) |
| PD | 16 PIN PLASTIC DIP (16P) |

| PART NUMBER | | FUNCTION | | | | |
|----------------|------|---|--|--|--|--|
| | 8200 | QUAD SWITCH, NORMALLY OPEN | | | | |
| | 8201 | QUAD SWITCH, NORMALLY CLOSED | | | | |
| | 8202 | QUAD SWITCH, TWO NORMALLY OPEN, TWO NORMALLY CLOSED | | | | |

REVISION HISTORY

| P/N | Rev | Date | Description of Change |
|--------|-----|----------|--|
| DS8200 | New | 10/18/12 | Initial Release |
| | Α | 10/22/12 | Remove 1MOhm resistor to GND from test circuits. Correct typo in Pin Descriptions |
| | В | 12/18/12 | Clarify that V+/V- pins must not be loaded. Used only for connection of bulk storage caps. |
| | С | 04/18/16 | Add leakage spec for power on condition. |
| | | | |

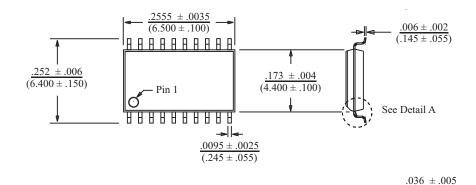


HI-8200 PACKAGE DIMENSIONS

20-PIN PLASTIC TSSOP

inches (millimeters)

Package Type: 20HS





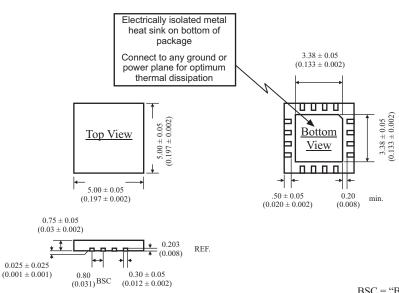
0° to 8° (.925 ± .125) 10° to 8° (.925 ± .125

BSC = "Basic Spacing between Centers" is theoretical true position dimension and has no tolerance. (JEDEC Standard 95)

16-PIN PLASTIC CHIP-SCALE PACKAGE

millimeters

Package Type: 16PCS1



BSC = "Basic Spacing between Centers" is theoretical true position dimension and has no tolerance. (JEDEC Standard 95)



HI-8200 PACKAGE DIMENSIONS

